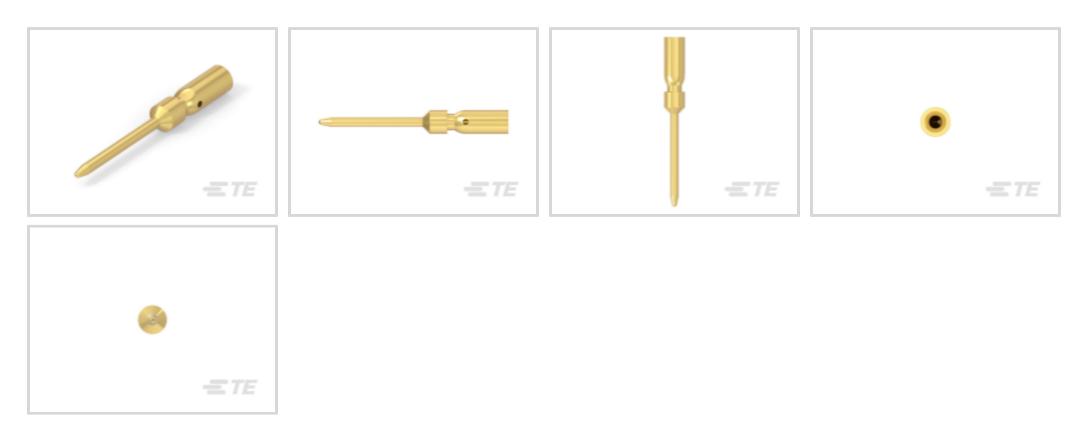
# **T3020001005-000 ~** ACTIVE

TE Internal #: T3020001005-000 Pin Contact, Gold (Au), Locking Spring Contact Retention, Crimp, Copper Alloy, Signal, -40 – 125 °F [-40 – 125 °C] View on TE.com >



Connectors > Contacts > Connector Contacts



### Contact Type: Pin

Contact Mating Area Plating Material: Gold (Au) Wire Contact Termination Area Plating Material: Gold Contact Retention Type Within Housing: Locking Spring Termination Method to Wire & Cable: Crimp

## Features

### **Product Type Features**

Discrete Wire Type	Stranded			
Electrical Characteristics				
Contact Resistance	5 mΩ			
Contact Features				
Contact Diameter	1 mm			
Contact Shape & Form	Rounded			
Contact Length	20 mm			
Contact Underplating Material	Copper or Nickel			
Barrel Type	Closed			
Contact Type	Pin			
Contact Mating Area Plating Material	Gold (Au)			
Wire Contact Termination Area Plating Material	Gold			
Contact Base Material	Copper Alloy			
Contact Current Rating (Max)	5 A			
Termination Features				

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Termination Method to Wire & Cable	Crimp
Product Terminates To	Wire & Cable
Mechanical Attachment	
Contact Retention Type Within Housing	Locking Spring
Usage Conditions	
Operating Temperature Range	-40 – 125 °C[-40 – 125 °F]
Operation/Application	
Circuit Application	Signal
Packaging Features	
Packaging Method	Bag & Box
<b>Product Compliance</b> For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235)

#### (235)

Candidate List Declared Against: JUNE 2023 (235) Does not contain REACH SVHC

Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Solder Process Capability

Halogen Content

Not reviewed for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulations, TE's information on SVHC in articles for this part number is still based on the European Chemical Agency (ECHA) 'Guidance on requirements for substances in articles' (Version: 2, April 2011), applying the 0.1% weight on weight concentration threshold at the finished product level. TE is aware of the European Court of Justice ruling of September 10th, 2015 also known as O5A (Once An Article Always An Article) stating that, in case of 'complex object', the threshold for a SVHC must be applied to both the product as a whole and simultaneously to each of the articles forming part of its composition. TE has evaluated this ruling based on the new ECHA "Guidance on requirements for substances in articles" (June 2017, version 4.0) and will be updating its statements accordingly.

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# **Compatible Parts**



# Customers Also Bought



TTE TE	=TE	=TE	₹. TE
TE Part #T2100182201-000	TE Part #T2240002120-001	TE Part #T2410001160-000	TE Part #T2210002010-000
BPSC-12/2/4-F	SCSF10-12	MCSM10-12	SDAF0.5-0.75



## Documents

Product Drawings MDAM-0.5

English

CAD Files

3D PDF

### T3020001005-000

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3D

Customer View Model ENG\_CVM\_CVM\_T3020001005-000\_A.2d\_dxf.zip English Customer View Model ENG\_CVM\_CVM\_T3020001005-000\_A.3d\_igs.zip English Customer View Model ENG\_CVM\_CVM\_T3020001005-000\_A.3d\_stp.zip English

Datasheets & Catalog Pages Bess Stacked Hybrid Connector

English

Product Specifications Application Specification

English